



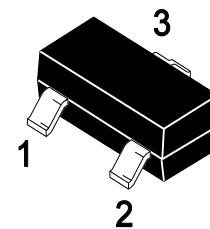
# PJM123NSA

## N- Enhancement Mode Field Effect Transistor

### Features

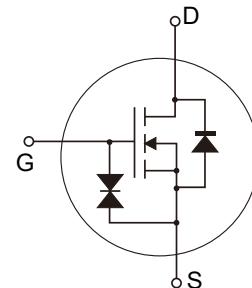
- ◆ Surface Mount Package
- ◆ Low  $R_{DS(ON)}$
- ◆ ESD protected(HBM) up to 2KV

SOT-23



1. Gate 2. Source 3. Drain  
Marking: B123

Schematic diagram



### Applications

- ◆ Switching Application
- ◆ Small Servo Motor Controls

### Absolute Maximum Ratings

( $T_c=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	0.17	A
Pulsed Drain Current $t_p=10\mu\text{s}$	$I_{DM}$	0.68	
Power Dissipation	$P_D$	0.9	W
Junction Temperature	$T_J$	150	C
Storage Temperature Range	$T_{STG}$	-55 to 150	C
Thermal Characteristics			
Parameter	Symbol	Typ.	Units
Maximum Junction-to-Ambient <sup>Note1</sup>	$R_{\theta JA}$	139	°C/W

**Electrical Characteristics**(T<sub>A</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	100	-	-	V
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±10	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1	μA
Gate Threshold Voltage <sup>Note2</sup>	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1	-	3	V
Drain-Source On-Resistance <sup>Note2</sup>	R <sub>DSS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.17A	-	3.5	6	Ω
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.17A	-	3.8	10	Ω
Forward transconductance <sup>Note2</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.17A	80	-	-	mS
<b>Dynamic Parameters</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz	-	29	60	pF
Output Capacitance	C <sub>oss</sub>		-	10	15	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	2	6	
<b>Switching Parameters</b>						
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =30V, V <sub>GS</sub> =10V R <sub>GEN</sub> =50Ω, I <sub>D</sub> =0.28A	-	-	8	ns
Turn-On Rise Time	t <sub>r</sub>		-	-	8	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	-	13	
Turn-Off Fall Time	t <sub>f</sub>		-	-	16	
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =0.22A	-	1.4	2	nC
Gate-Source Charge	Q <sub>gs</sub>		-	0.15	0.25	
Gate-Drain Charge	Q <sub>gd</sub>		-	0.2	0.4	
<b>Drain-source Diode Parameters</b>						
Source-Drain Diode Current	I <sub>s</sub>		-	-	0.17	A
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>s</sub> = 0.34A	-	-	1.3	V

Notes:1. Surface mounted on FR4 board using the minimum recommended pad size.

2. Pulse Test: Pulse width=300μs, duty cycle≤2%.

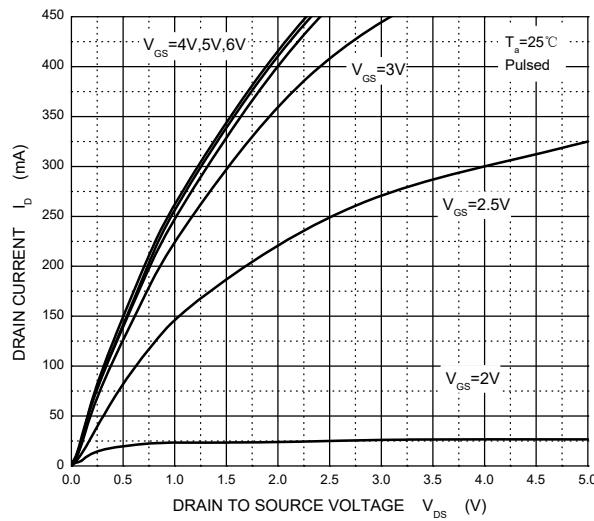


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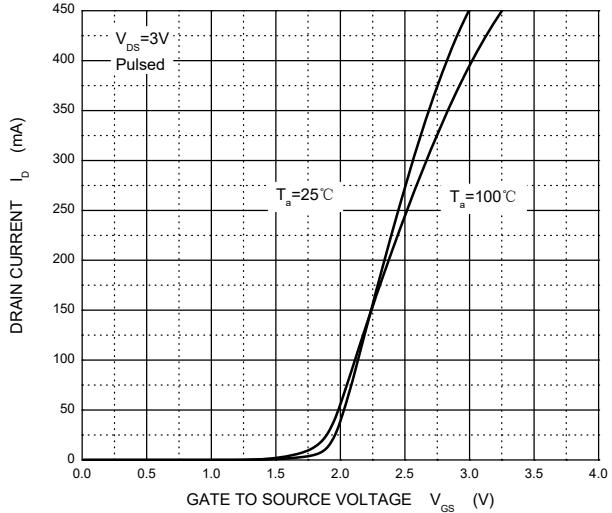
## N- Enhancement Mode Field Effect Transistor

### Ratings And Characteristic Curves

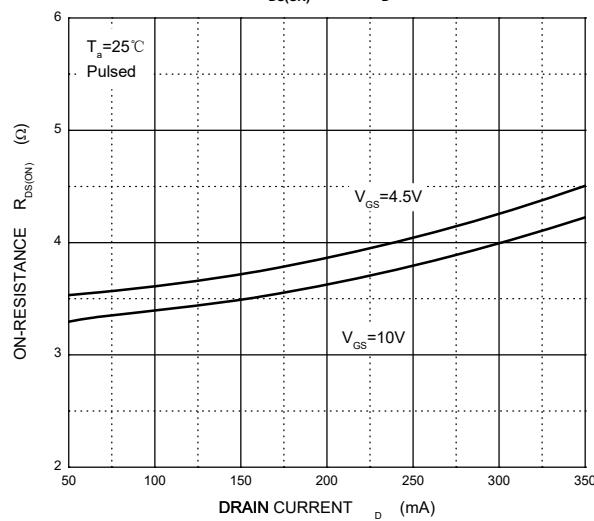
Output Characteristics



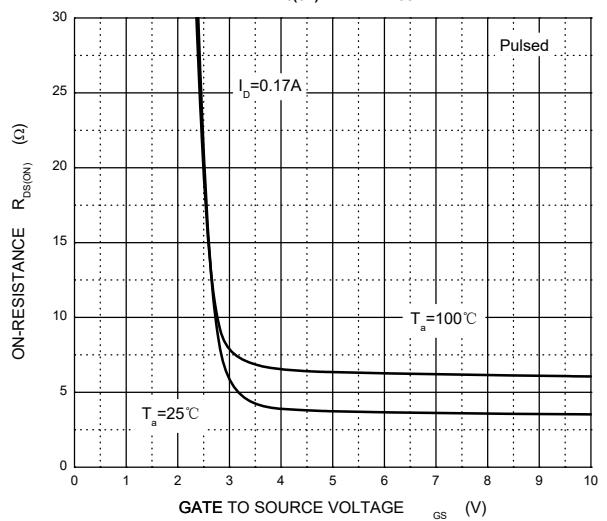
Transfer Characteristics



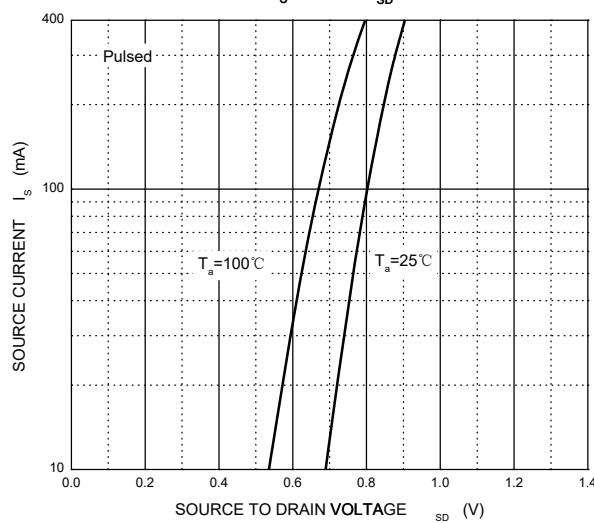
$R_{DS(ON)}$  —  $I_D$



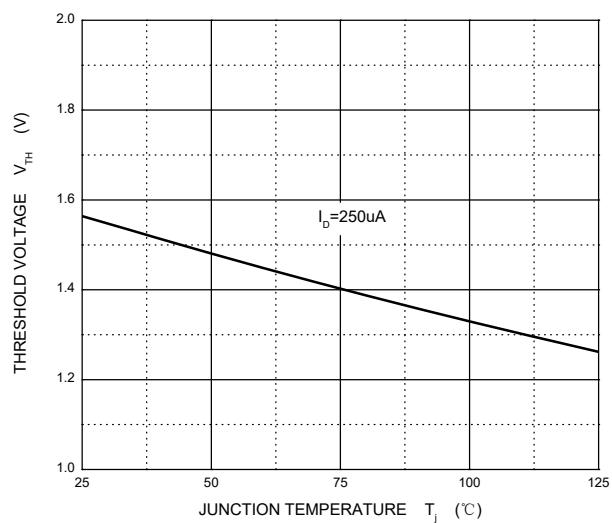
$R_{DS(ON)}$  —  $V_{GS}$



$I_S$  —  $V_{SD}$



Threshold Voltage



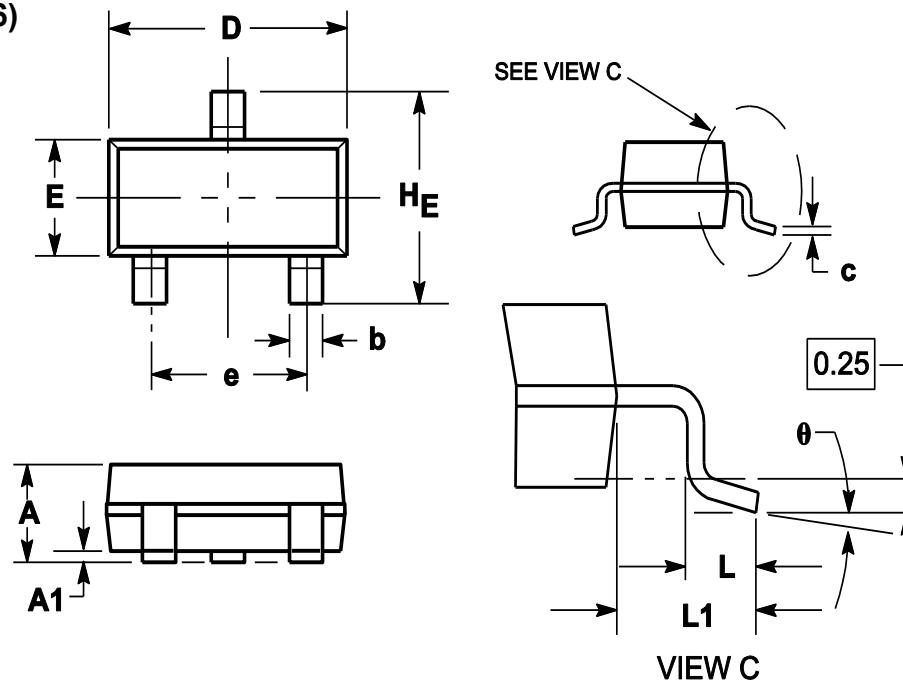


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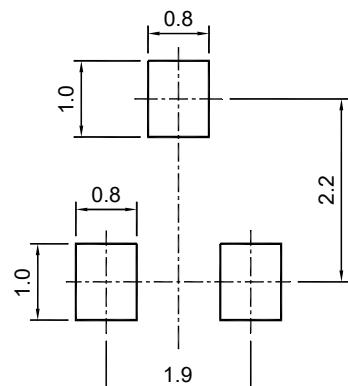
## N- Enhancement Mode Field Effect Transistor

### Package Outline

SOT-23 (TO-236)



Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	0.900	1.025	1.150
A1	0.000	0.050	0.100
b	0.300	0.400	0.500
c	0.080	0.115	0.150
D	2.800	2.900	3.000
E	1.200	1.300	1.400
HE	2.250	2.400	2.550
e	1.800	1.900	2.000
L1	0.550REF		
L	0.300		0.500
θ	0°		8°



SOT-23 (TO-236)

**Recommended soldering pad**

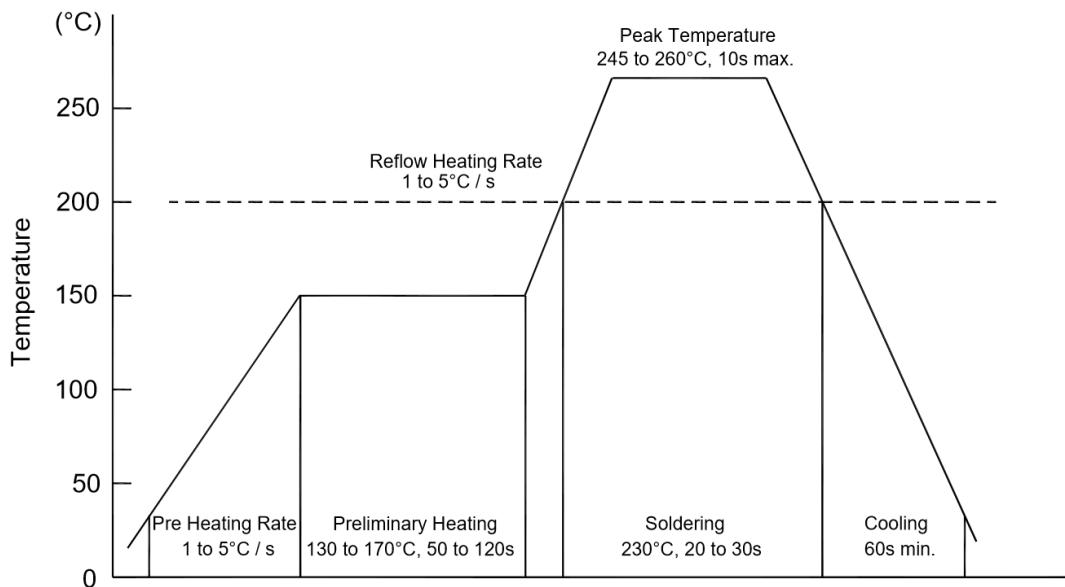
### Ordering Information

Device	Package	Shipping
PJM123NSA	SOT-23	3000/Reel&Tape(7inch)



## Conditions of Soldering and Storage

### ◆ Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

### ◆ Conditions of hand soldering

- Temperature: 370 °C
- Time: 3s max.
- Times: one time

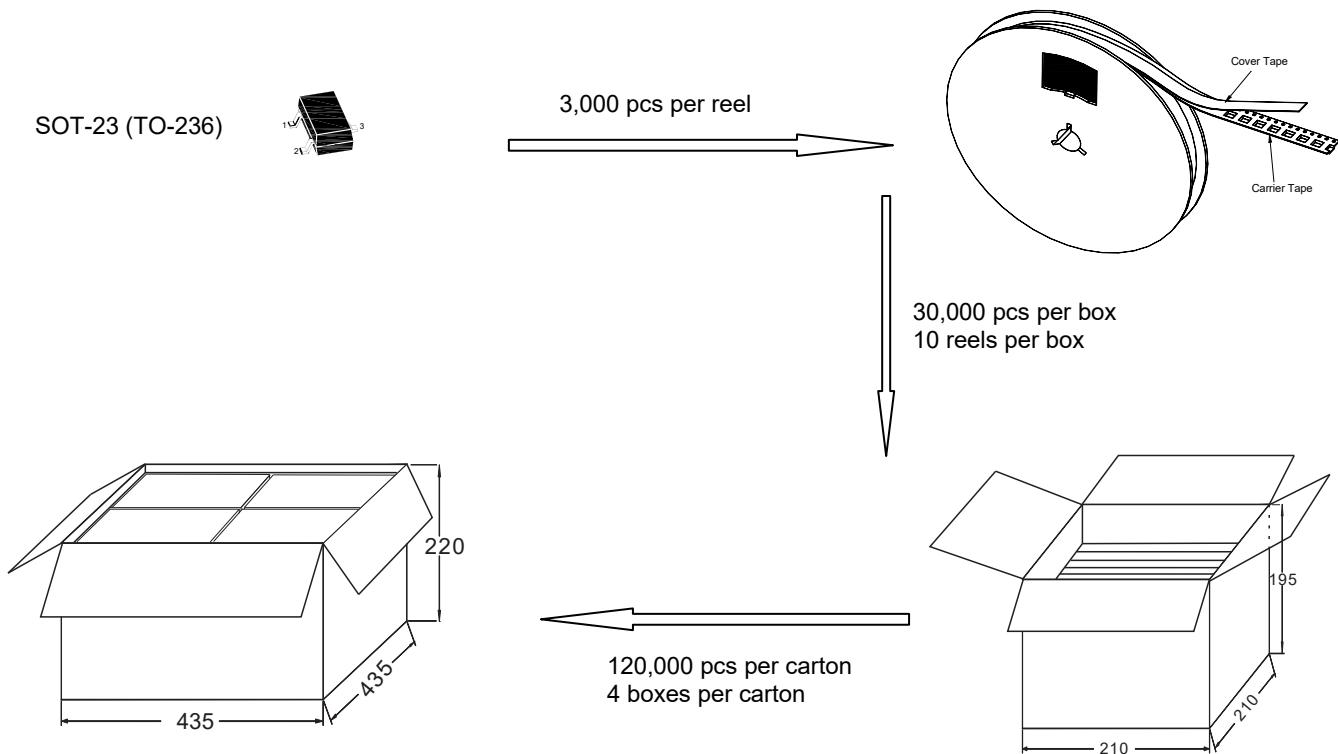
### ◆ Storage conditions

- **Temperature**  
5 to 40 °C
- **Humidity**  
30 to 80% RH
- **Recommended period**  
One year after manufacturing

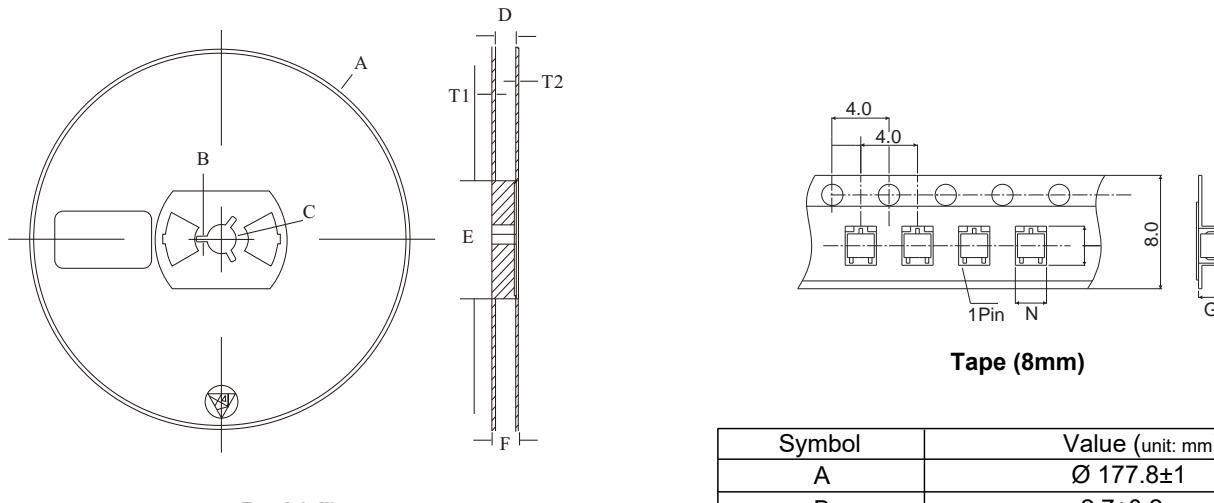


## Package Specifications

### ◆ The method of packaging



### ◆ Embossed tape and reel data



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